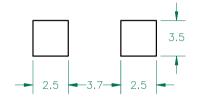
MGV0603R68M-10

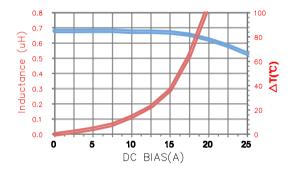
PHYSICAL DIMENSIONS:

Α	7.30	±	0.50
В	6.70	±	0.30
С	3.00	\pm	0.30
D	2.90	±	0.30

E 1.60 ± 0.50

LAND PATTERNS FOR REFLOW SOLDERING

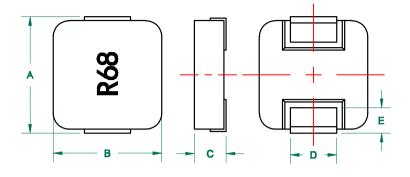




ELECTRICAL SPECIFICATION @ 25°C

	Min	Nom	Max
INDUCTANCE (uH)			
L @ 100 KHz/0.25V	0.544	0.680	0.816
± 20%			
DCR (Ω)			0.0055

Saturation Current ³ Isat (A)	25
Temperature Rise Current Irms ⁴(A)	15.50





UNCONTROLLED DOCUMENT





NOTES: UNLESS OTHERWISE SPECIFIED

- 1.COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 2.OPERATION TEMPERATURE RANGE: -40°C~+125°C (INCLUDING SELF-HEATING).
- 3.DEFINITION OF SATURATION CURRENT (ISAT): DC CURRENT AT WHICH THE INDUCTANCE DROPS $\leq 25\%$ FROM ITS VALUE WITHOUT CURRENT (Ta=25 ± 5 °C).
- 4.DEFINITION OF TEMPERATURE RISE CURRENT (IRMS): DC CURRENT THAT CAUSES THE TEMPERATURE RISE ($\Delta \text{T} \leq 40^{\circ}\text{C}$) FROM 25°C AMBIENT.

DIMENSIONS ARE IN mm. This print is the property of Laird			.					
				Tech and is loaned in confidence subject to return upon request a with the understanding that no copies shall be made without the written consent of Laird Tech. All rights to design or invention are reserved.	nd	Laird		
				PROJECT/PART NUMBER:	REV	PART T		DRAWN BY:
С	CHANGE NOTE 2.3.4	09/24/12	QIU	MGV0603R68M-10			WER ICTOR	QIU
В	REVISE DIMENSIONS	06/27/12	QIU	DATE: 06/27/12 sc		NTS		
Α	ORIGINAL DRAFT	06/27/12	QIU		00L #	1413	_	
REV	DESCRIPTION	DATE	INT			-	2	of 2